

HD74LV2GT157A

2-channle Multiplexer / CMOS Logic Level Shifter

REJ03D0150-0200Z (Previous ADE-205-686A (Z)) Rev.2.00 Oct.23.2003

Description

The HD74LV2GT157A has 2—channel multiplexer in 8 pin package. The input protection circuitry on this device allows over voltage tolerance on the input, allowing the device to be used as a logic—level translator from 3.0 V CMOS Logic to 5.0 V CMOS Logic or from 1.8 V CMOS logic to 3.0 V CMOS Logic while operating at the high-voltage power supply. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- TTL compatible input level.
 - Supply voltage range: 3.0 to 5.5 V

Operating temperature range: -40 to +85°C

• Logic-level translate function

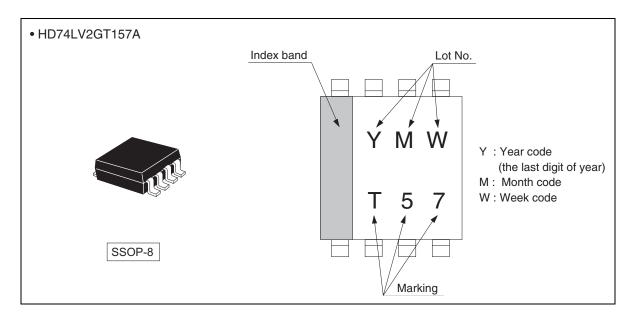
 $3.0 \text{ V CMOS logic} \rightarrow 5.0 \text{ V CMOS logic} (@V_{CC} = 5.0 \text{ V})$

1.8 V or 2.5 V CMOS logic \rightarrow 3.3 V CMOS logic (@V_{CC} = 3.3 V)

- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V) All outputs V_{O} (Max.) = 5.5 V (@V_{CC} = 0 V)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV2GT157AUSE	SSOP-8 pin	TTP-8DBV	US	E (3,000 pcs/reel)

Outline and Article Indication

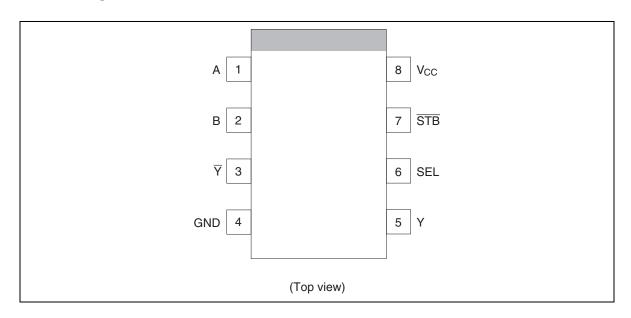


Function Table

Inputs				Outputs		
STB	SEL	Α	В	Y	Ÿ	
Н	Х	Х	Х	L	Н	
L	L	L	Х	L	Н	
L	L	Н	Х	Н	L	
L	Н	X	L,	L	Н	
L	Н	Χ	Н	Н	L	

H : High level
L : Low level
X : Immaterial

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V_{CC}	-0.5 to 7.0	V	
Input voltage range *1	Vı	-0.5 to 7.0	V	
Output voltage range *1, 2	Vo	-0.5 to V_{CC} + 0.5	V	Output : H or L
		-0.5 to 7.0		V _{CC} : OFF
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	I _{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	Io	±25	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes:

The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

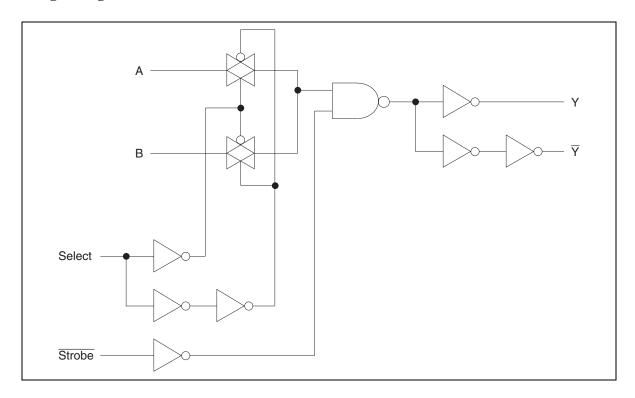
- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	3.0	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	
Output current	I _{OL}	_	6	mA	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	12	 ;	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OH}	_	-6	 ;	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	100	ns / V	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}C$

Item	Symbo	I V _{CC} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	3.0 to 3.6	1.5	_	_	V	
		4.5 to 5.5	2.0	_	_		
	V _{IL}	3.0 to 3.6	_		0.6	_	
		4.5 to 5.5	_	_	0.8		
Hysteresis voltage	V _H	3.3	_	0.10	_	V	$V_T^+ - V_T^-$
		5.0	_	0.15	_		
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1		_	V	I _{OH} = -50 μA
		3.0	2.48	_	_	_	I _{OH} = -6 mA
		4.5	3.8	_	_	_	$I_{OH} = -12 \text{ mA}$
	V _{OL}	Min to Max	_	_	0.1	_	$I_{OL} = 50 \mu A$
		3.0	_	_	0.44	_	I _{OL} = 6 mA
		4.5	_	_	0.55	_	I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	_		±1	μΑ	V _{IN} = 5.5 V or GND
Quiescent supply current	Icc	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
	ΔI_{CC}	5.5	_	_	1.5	mA	One input $V_{IN} = 3.4 \text{ V}$, other input V_{CC} or GND
Output leakage current	I _{OFF}	0	_	_	5	μА	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	5.0		3.0		pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

• $V_{CC} = 3.3 \pm 0.3 \text{ V}$

		Ta = 2	25°C		Ta = -	40 to 85°C		Test	FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	7.5	11.5	1.0	13.0	ns	C _L = 15 pF	A or B	Υ
delay time t _{PHL}	t _{PHL}	_	10.0	15.0	1.0	17.0		C _L = 50 pF	_	
		_	10.0	15.0	1.0	17.5		C _L = 15 pF	SEL	Υ
		_	12.5	18.5	1.0	21.0		C _L = 50 pF	_	
		_	8.5	14.0	1.0	16.0	_	C _L = 15 pF	STB	Υ
		_	11.0	17.5	1.0	19.5		C _L = 50 pF	_	

• $V_{CC} = 5.0 \pm 0.5 \text{ V}$

		Ta = 2	25°C		Ta = -	40 to 85°C		Test	FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	5.1	7.4	1.0	8.5	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	6.6	9.4	1.0	10.5	_	C _L = 50 pF	_	
		_	6.3	9.1	1.0	10.5	_	C _L = 15 pF	SEL	Υ
		_	7.8	11.1	1.0	12.5	_	C _L = 50 pF	=	
		_	5.6	8.6	1.0	10.0	_	C _L = 15 pF	STB	Υ
		_	7.1	10.6	1.0	12.0	_	C _L = 50 pF	_	

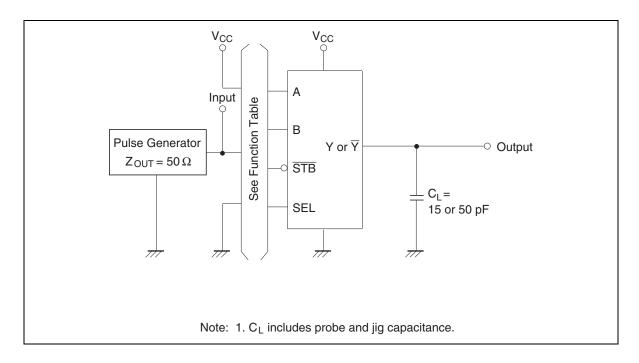
Operating Characteristics

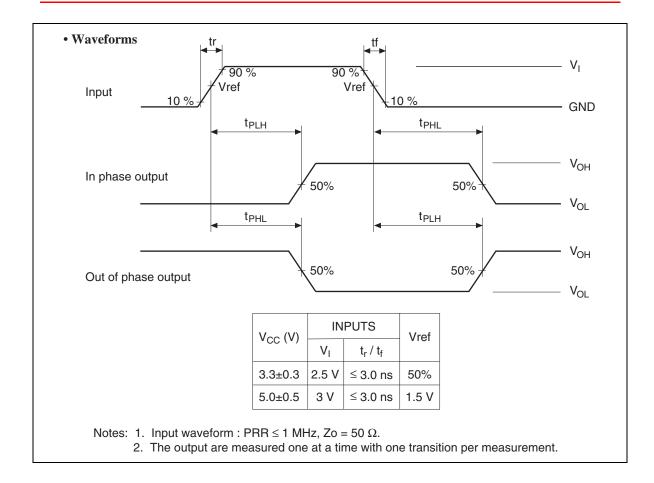
• $C_L = 50 pF$

Ta = 25°C

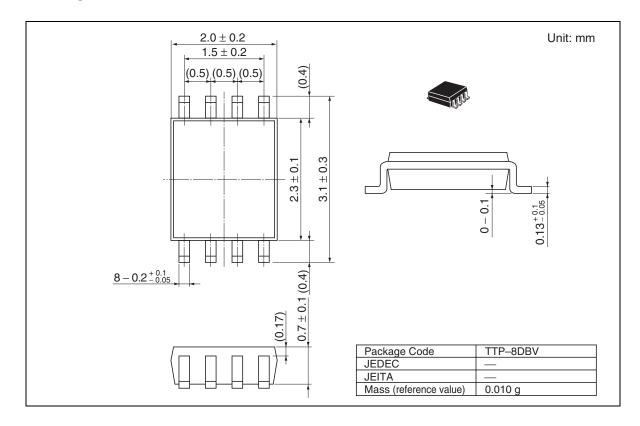
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C_{PD}	5.0	_	35.0	_	pF	f = 10 MHz

Test Circuit





Package Dimensions



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